SMAJ-HRA Series

Surface Mount - 400W





Agency Approvals

Agency	Agency File/Certificate Number
<i>91</i>	E230531

Maximum Ratings & Thermal Characteristics

(T_△=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation ($I_{PP} \times V_C$) by 10/1000 μ s Waveform (Fig.2) (Note 1), (Note 2)	P _{PPM}	400	W
Power Dissipation on Infinite Heat Sink at T_L =50°C	P _D	3.3	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I _{FSM}	60	А
Maximum Instantaneous Forward Voltage at 25A for Unidirectional Only	V _F	3.5	V
Operating Temperature Range	T _J	-65 to 150	°C
Storage Temperature Range	T _{STG}	-65 to 175	°C
Typical Thermal Resistance Junction to Lead	$R_{\theta JL}$	30	°C/W
Typical Thermal Resistance Junction to Ambient	R _{eJA}	120	°C/W

Notes

- 1. Non-repetitive current pulse , per Fig. 4 and derated above T, (initial) =25°C per Fig. 3.
- 2. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal.
- Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional component only

Description

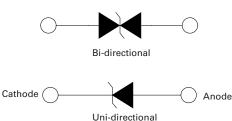
The SMAJ-HRA High Reliability series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

Features

- Excellent clamping capability
- Typical $I_R \le 1 \mu A$ for $V_R > 10 V$
- For surface mounted applications to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- ESD protection of data lines in accordance with IEC 61000-4-2, 30kV(Air), 30kV (Contact)
- EFT protection of data lines in accordance with IEC 61000-4-4
- Built-in strain relief
- 400W Peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycle): 0.01%
- Fast response time: typically less than 1.0ps from 0 Volts to V_{BB} min

- Glass passivated junction
- Low inductance
- High temperature to reflow soldering guaranteed: 260°C/40sec
- V_{BR} @ $T_J = V_{BR}$ @ 25° C x ($1 + \alpha$ T x ($T_J 25$))(α T:Temperature Coefficient, typical value is 0.1%) Coefficient, typical value
- UL Recognized epoxy meeting flammability rating V-0
- Meet MSL level1, per J-STD-020, LF maximun peak of 260°C
- Matte tin lead-free Plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Functional Diagram



Applications

TVS Components are ideal for the protection of I/O Interfaces, $V_{\rm cc}$ bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.



Electrical Characteristics

Part Number (Uni)	Part Number (Bi)	Number	Stand off Voltage V _R (Voltage V _R	kdown Test ge V _{BR} Current cs) @ I _T I _T		Maximum Clamping Voltage V _c @ I	Maximum Peak Pulse Current I	Maximum Reverse Leakage I _R @ V _R	Agency Approval		
,		UNI	ВІ	(Volts)	MIN	MAX	(mA)	(V)	(A)	(μ A)	
SMAJ6.0A-HRA	SMAJ6.0CA-HRA	AGH	WGH	6.0	6.67	7.37	10	10.3	38.8	800	X
SMAJ9.0A-HRA	SMAJ9.0CA-HRA	AVH	WVH	9.0	10.00	11.10	1	15.4	26.0	10	X
SMAJ10A-HRA	SMAJ10CA-HRA	AXH	WXH	10.0	11.10	12.30	1	17.0	23.5	5	X
SMAJ11A-HRA	SMAJ11CA-HRA	AZH	WZH	11.0	12.20	13.50	1	18.2	22.0	1	X
SMAJ12A-HRA	SMAJ12CA-HRA	BEH	XEH	12.0	13.30	14.70	1	19.9	20.1	1	X
SMAJ13A-HRA	SMAJ13CA-HRA	BGH	XGH	13.0	14.40	15.90	1	21.5	18.6	1	X
SMAJ14A-HRA	SMAJ14CA-HRA	BKH	XKH	14.0	15.60	17.20	1	23.2	17.2	1	X
SMAJ15A-HRA	SMAJ15CA-HRA	BMH	XMH	15.0	16.70	18.50	1	24.4	16.4	1	X
SMAJ16A-HRA	SMAJ16CA-HRA	BPH	XPH	16.0	17.80	19.70	1	26.0	15.4	1	X
SMAJ17A-HRA	SMAJ17CA-HRA	BRH	XRH	17.0	18.90	20.90	1	27.6	14.5	1	X
SMAJ18A-HRA	SMAJ18CA-HRA	BTH	XTH	18.0	20.00	22.10	1	29.2	13.7	1	X
SMAJ20A-HRA	SMAJ20CA-HRA	BVH	XVH	20.0	22.20	24.50	1	32.4	12.3	1	X
SMAJ26A-HRA	SMAJ26CA-HRA	CEH	YEH	26.0	28.90	31.90	1	42.1	9.5	1	Χ
SMAJ33A-HRA	SMAJ33CA-HRA	CMH	YMH	33.0	36.70	40.60	1	53.3	7.5	1	X
SMAJ36A-HRA	SMAJ36CA-HRA	CPH	YPH	36.0	40.00	44.20	1	58.1	6.9	1	X
SMAJ45A-HRA	SMAJ45CA-HRA	CVH	YVH	45.0	50.00	55.30	1	72.7	5.5	1	X

Note:

1. For bidirectional type having $\rm V_{\rm R}$ of 10 volts and less, the $\rm I_{\rm R}$ limit is double.

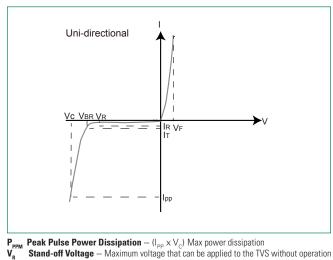


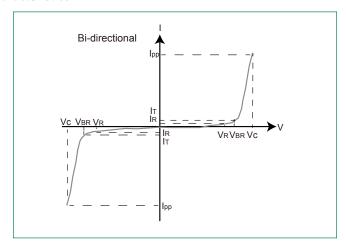
Screen Process

100% Vision Inspection	MIL-STD-750 method 2074
100% High Temperature Storage Life (168hrs,175°C)	MIL-STD-750 method 1031
100% X-RAY inspection	MIL-STD-750 method 2076
100% Temperature Cycle Test (-55 to 150°C, 20 cycles, dwell time 15 min)	MIL-STD-750 method 1051
100% Reflow (2X)	JEDEC J-STD-020
100% Surge Test (2x)	MIL-STD-750 method 4066
100% HTRB 150°C Bias=V _R (80% breakdown voltage, 96hrs, and each direction 96hrs for Bi-directional products)	MIL-STD-750 method 1038
Final Electrical Test (100% 3 sigma limit, 100% dynamic test and PAT limit)	MIL-STD-750 method 4016.4021.4011

Note: Up-screen program can be specified by customer's request by contacting Littelfuse customer service

I-V Curve Characteristics





- **Stand-off Voltage** Maximum voltage that can be applied to the TVS without operation
- Breakdown Voltage Maximum voltage that flows though the TVS at a specified test current (I_T)
- Clamping Voltage -- Peak voltage measured across the TVS at a specified lppm (peak impulse current)
- Reverse Leakage Current -- Current measured at V_R
- Forward Voltage Drop for Uni-directional



Ratings and Characteristic Curves (T_A=25°C unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

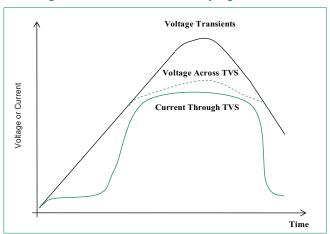


Figure 2 - PPeak Pulse Power Rating Curve

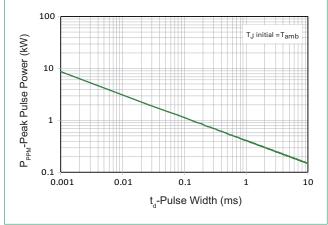


Figure 3 - Peak Pulse Power Derating Curve

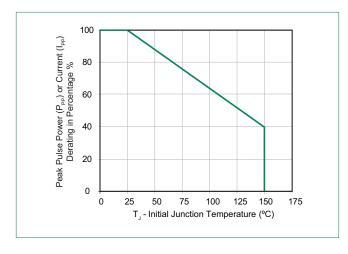


Figure 4 - Pulse Waveform

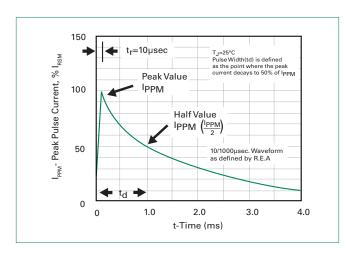


Figure 5 - Typical Junction Capacitance

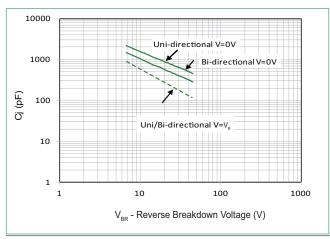
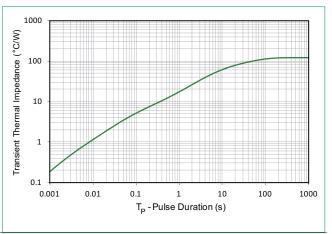


Figure 6 - Typical Transient Thermal Impedance





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Figure 7 - Maximum Non-Repetitive Forward Surge Current Uni-Directional Only

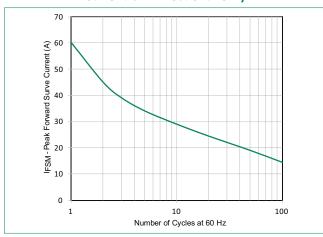
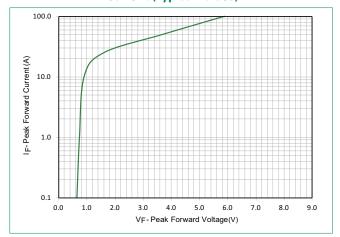
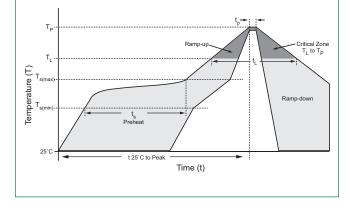


Figure 8 - Peak Forward Voltage Drop vs Peak Forward Current (Typical Values)



Soldering Parameters

Reflow Cond	Lead-free assembly	
	-Temperature Min (T _{s(min)})	150°C
Pre Heat	-Temperature Max (T _{s(max)})	200°C
	-Time (min to max) (t _s)	60 - 120 secs
Average ram	3°C/second max	
$T_{\text{S(max)}}$ to T_{L} -	3°C/second max	
Reflow	-Temperature (T _L) (Liquidus)	217°C
	-Time (min to max) (t _s)	60 - 150 seconds
Peak Temper	260+0/-5 °C	
Time within	30 seconds	
Ramp-down	6°C/second max	
Time 25°C to	8 minutes max.	
Do not exce	260°C	



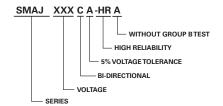
Physical Specifications

Weight	0.002 ounce, 0.061 gram
Case	JEDEC DO-214AC Molded Plastic over glass passivated junction
Polarity	Color band denotes cathode except bidirectional
Terminal	Matte Tin-plated leads. Solderable per JESD22-B102

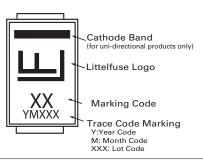
Environmental Specifications

High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, Level 1
H3TRB	JESD22-A101
RSH	JESD22-A111

Part Numbering System

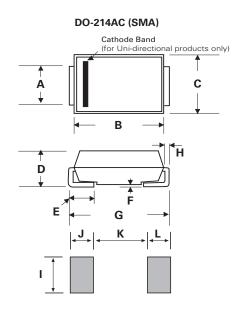


Part Marking System





Dimensions

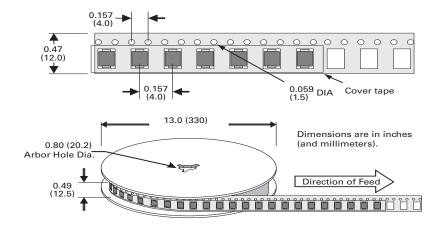


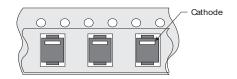
Dimensions	Inc	hes	Millimeters		
	Min	Max	Min	Max	
Α	0.049	0.065	1.250	1.650	
В	0.157	0.181	3.990	4.600	
С	0.095	0.110	2.400	2.790	
D	0.075	0.090	1.900	2.290	
E	0.030	0.060	0.780	1.520	
F	-	0.008	-	0.203	
G	0.189	0.208	4.800	5.280	
Н	0.006	0.012	0.152	0.305	
1	0.070	-	1.800	-	
J	0.082	-	2.100	-	
K	-	0.090	-	2.300	
L	0.082	-	2.100	-	

Packaging

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMAJ-xxxXX-HRA	DO-214AC	5000	Tape & Reel - 12mm tape/13" reel	EIA STD RS-481

Tape and Reel Specification





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